



DSC10A065LP

SILICON CARBIDE SCHOTTKY DIODE

Product Summary

V _{RRM} (V)	I ₀ (A)	V _{F (Max)} (V) @ +25°C	I _{R (Typ)} (μΑ) @ +25°C
650	10	1.5	0.19

Description and Applications

Packaged in the robust industry-standard DFN8080 package, the DSC10A065LP provides excellent reverse leakage stability at high temperatures. It is ideal for use as a rectifier, freewheel diode, or blocking diode in:

- Power factor correction
- Industrial motor drivers
- Power inverters
- SMPS
- UPS

Features and Benefits

- Low Conduction and Switching Loss
- High-Temperature Application
- Positive Temperature Coefficient on V_F
- Fast Reverse Recovery
- High Surge Current Capability
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Package: DFN8080
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020

(Heatsink)

- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.214 grams (Approximate)



Ordering Information (Note 4)

Orderable Part Number	Packaga	Packing		
	Package	Qty.	Carrier	
DSC10A065LP-13	DFN8080	2,500	Reel	

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

DFN8080

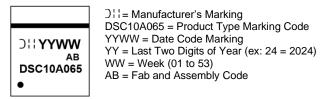
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



Maximum Ratings (@Tc = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage DC Blocking Voltage	V _{RRM} Vdc	650	V
Average Rectified Output Current	lo	10	А
Non-Repetitive Peak Forward Surge Current 10ms Half Sine Waveform	IFSM	55	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case (Notes 5, 6, 7)	Rejc	1.23	°C/W
Typical Thermal Resistance, Junction to Ambient (Notes 5, 6, 7)	Reja	3.83	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +175	°C

Notes: 5. Thermal resistance test performed in accordance with JESD-51.

6. The unit mounted on copper heatsink ink-80mm*80mm*1.5mm.

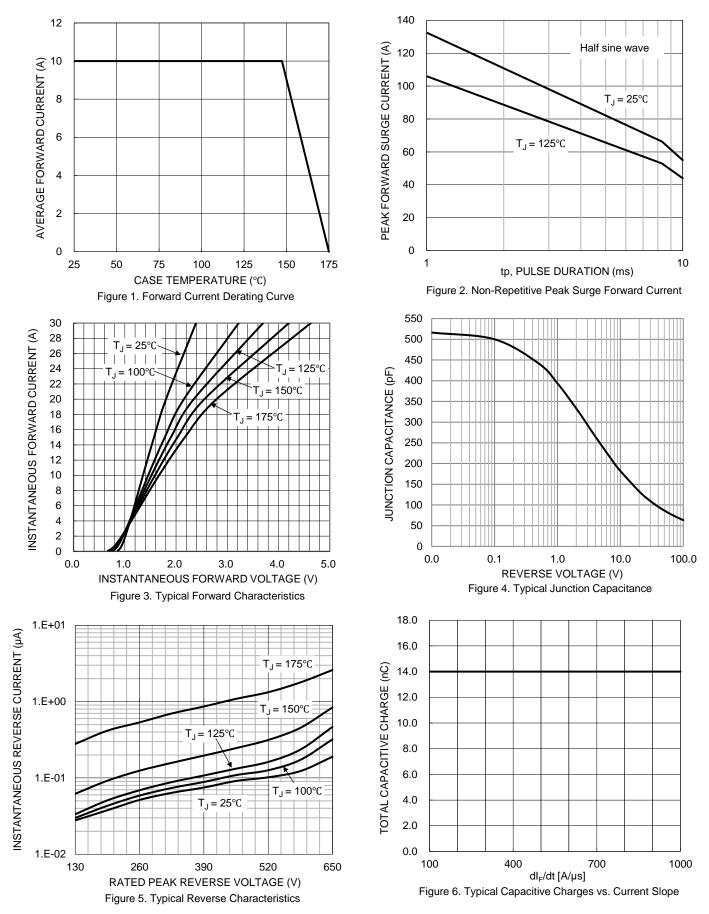
7. Device mounted on 1inch² copper pad, 2oz. The heat generated must be less than the thermal conductivity from junction to case: $dP_D/dT_J < 1/R_{\theta JC}$ or junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$.

Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition
Reverse Voltage	V_{BR}	650		—	V	I _R = 0.1mA
Forward Voltage Drop	Vf		1.35 1.66	1.50 2.25	V V	IF = 10A, TJ = +25°C IF = 10A, TJ = +175°C
Leakage Current	IR		0.19 2.59	20 190	μA	V _R = 650V, T _J = +25°C V _R = 650V, T _J = +175°C
Total Capacitive Charge	Qc	_	14	_	nC	IF = 10A, di/dt = 200A/µs, V _R = 400V, T _J = +25°C
Total Capacitance	Ст		516 394 96		pF	$V_R = 0.1V, T_J = +25^{\circ}C, f = 1MHz$ $V_R = 1V, T_J = +25^{\circ}C, f = 1MHz$ $V_R = 40V, T_J = +25^{\circ}C, f = 1MHz$

Electrical Characteristics (@T_C = +25°C, unless otherwise specified.)



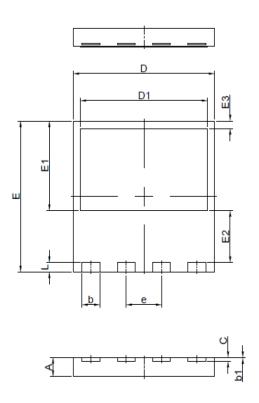
DSC10A065LP





Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

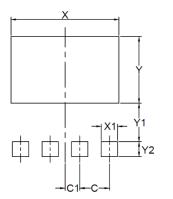


	DFN8080				
DIM.	MIN.	MAX.	TYP.		
Α	0.90	1.10	1.00		
b	0.90	1.10	1.00		
b1	0	0.05	0.02		
С	0.20 REF.				
D	7.90	8.10	8.00		
D1	7.10	7.30	7.20		
E	7.90	8.10	8.00		
E1	4.65	4.85	4.75		
E2	2.65	2.85	2.75		
E3	0.30	0.50	0.40		
е	2.0 BSC				
L	0.40	0.60	0.50		
All Dimension in millimeter					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

DFN8080



	Millimeters		
Dim.	www.		
	DFN8080		
С	2.0		
C1	1.0		
Х	7.3		
X1	1.1		
Y	4.5		
Y1	2.6		
Y2	1.0		

DFN8080



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